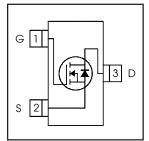
# International Rectifier

V <sub>DSS</sub>	40	٧
V <sub>GS Max</sub>	± 16	V
<b>R</b> <sub>DS(on) max</sub> (@V <sub>GS</sub> = 10V)	56	$\mathbf{m}\Omega$
$R_{DS(on) max}$ (@V <sub>GS</sub> = 4.5V)	78	mΩ

### IRLML0040TRPbF

HEXFET® Power MOSFET





#### Application(s)

- Load/ System Switch
- DC Motor Drive

#### **Features and Benefits**

#### **Features**

Low $R_{DS(on)}$ ( $\leq 56m\Omega$ )
Industry-standard pinout
Compatible with existing Surface Mount Techniques
RoHS compliant containing no lead, no bromide and no halogen
MSL1, Consumer qualification

#### Benefits

results in

Lower switching losses
Multi-vendor compatibility
Easier manufacturing
Environmentally friendly
Increased reliability

**Absolute Maximum Ratings** 

Symbol Parameter		Max.	Units	
V <sub>DS</sub>	Drain-Source Voltage	40	V	
<sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	3.6		
<sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	2.9	Α	
DM	Pulsed Drain Current	15		
P <sub>D</sub> @T <sub>A</sub> = 25°C	Maximum Power Dissipation	1.3	14/	
P <sub>D</sub> @T <sub>A</sub> = 70°C	Maximum Power Dissipation	0.8	W	
Linear Derating Factor		0.01	W/°C	
GS Gate-to-Source Voltage		± 16	V	
T <sub>J</sub> , T <sub>STG</sub> Junction and Storage Temperature Range		-55 to + 150	°C	

#### **Thermal Resistance**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient ③		100	°C/W
$R_{\theta JA}$	Junction-to-Ambient (t<10s)		99	O/ VV

#### **ORDERING INFORMATION:**

See detailed ordering and shipping information on the last page of this data sheet.

Notes ① through ④ are on page 10 www.irf.com

#### Electric Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	40			٧	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.04		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
В	Static Drain-to-Source On-Resistance		44	56	0	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.6A ②
R <sub>DS(on)</sub>	Static Dialif-to-Source Off-nesistatice		62	78	mΩ	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 2.9A ②
$V_{GS(th)}$	Gate Threshold Voltage	1.0	1.8	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 25\mu A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20		$V_{DS} = 40V, V_{GS} = 0V$
	Diani-to-Source Leakage Current			250	μA	$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			100	nA	V <sub>GS</sub> = 16V
	Gate-to-Source Reverse Leakage			-100	ΠA	V <sub>GS</sub> = -16V
$R_{G}$	Internal Gate Resistance		1.1		Ω	
gfs	Forward Transconductance	6.2			S	$V_{DS} = 10V, I_{D} = 3.6A$
$Q_g$	Total Gate Charge		2.6	3.9		$I_D = 3.6A$
$Q_{gs}$	Gate-to-Source Charge		0.7		nC	$V_{DS} = 20V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		1.4			V <sub>GS</sub> = 4.5V ②
t <sub>d(on)</sub>	Turn-On Delay Time		5.1			$V_{DD} = 20V$
t <sub>r</sub>	Rise Time		5.4			$I_D = 1.0A$
t <sub>d(off)</sub>	Turn-Off Delay Time		6.4		ns	$R_G = 6.8 \Omega$
t <sub>f</sub>	Fall Time		4.3			$V_{GS} = 4.5V$
C <sub>iss</sub>	Input Capacitance		266			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance	_	49		pF	$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance	_	29			f = 1.0MHz

Source - Drain Ratings and Characteristics

Symbol	Parameter	Min.	Tvp.	Max.	Units	Conditions
Is	Continuous Source Current (Body Diode)	_		1.3		MOSFET symbol showing the
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			15		integral reverse p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C$ , $I_S = 1.3A$ , $V_{GS} = 0V$ ②
t <sub>rr</sub>	Reverse Recovery Time		10		ns	$T_J = 25^{\circ}C$ , $V_R = 32V$ , $I_F = 1.3$ A
Q <sub>rr</sub>	Reverse Recovery Charge		9.3		nC	di/dt = 100A/µs ②

## International TOR Rectifier

### IRLML0040TRPbF

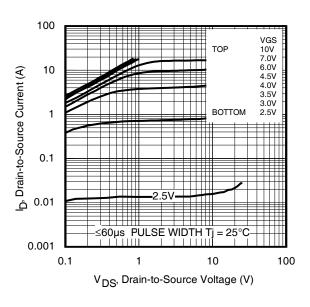


Fig 1. Typical Output Characteristics

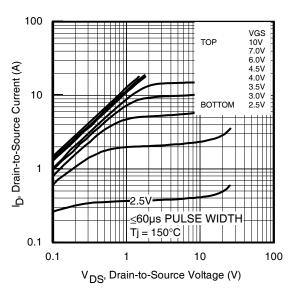


Fig 2. Typical Output Characteristics

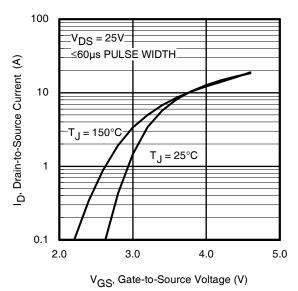
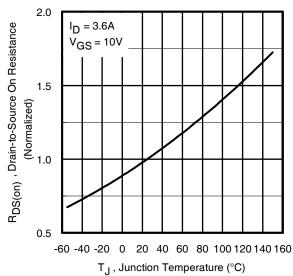
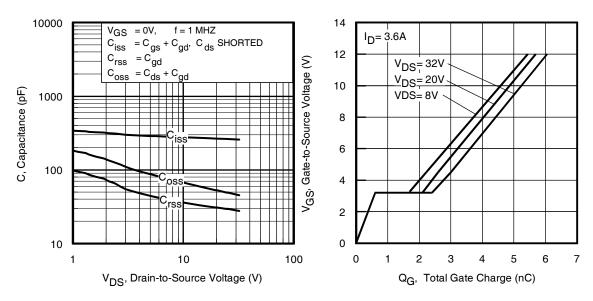


Fig 3. Typical Transfer Characteristics

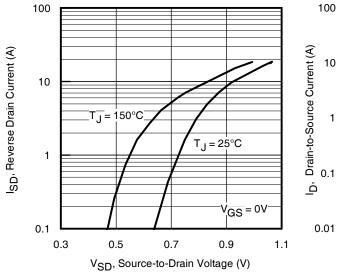


**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

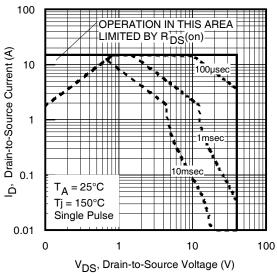
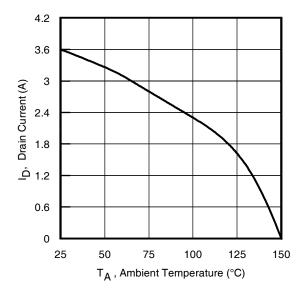


Fig 8. Maximum Safe Operating Area

# International TOR Rectifier

### IRLML0040TRPbF



**Fig 9.** Maximum Drain Current Vs. Ambient Temperature

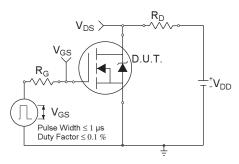


Fig 10a. Switching Time Test Circuit

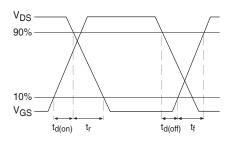


Fig 10b. Switching Time Waveforms

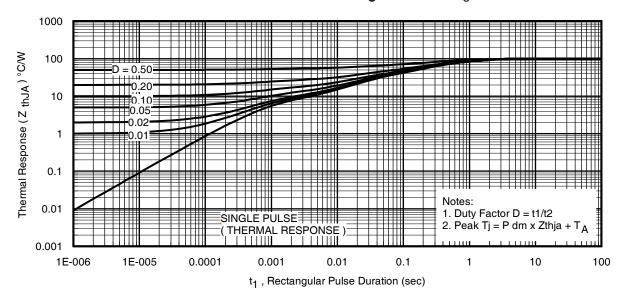
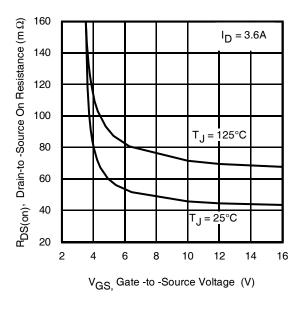


Fig 11. Typical Effective Transient Thermal Impedance, Junction-to-Ambient

International

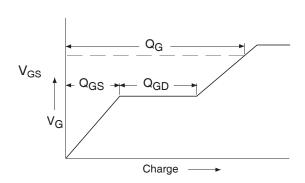
TOR Rectifier



 $R_{\mbox{\footnotesize DS}}(\mbox{on}), \mbox{ Drain-to -Source On Resistance } (\mbox{$\mathfrak{m}\Omega$})$ 250 200 150 100 Vgs = 4.5VVgs = 10V 50 0 5 20 25 35 0 15 30 I<sub>D</sub>, Drain Current (A)

**Fig 12.** Typical On-Resistance Vs. Gate Voltage

Fig 13. Typical On-Resistance Vs. Drain Current





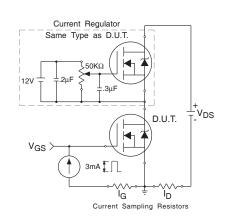
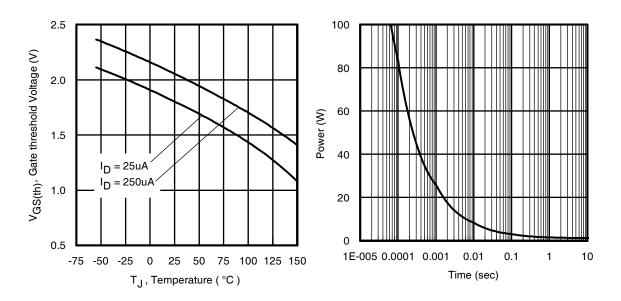


Fig 14b. Gate Charge Test Circuit

# International IOR Rectifier

### IRLML0040TRPbF



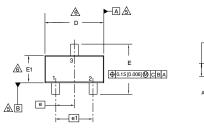
**Fig 15.** Typical Threshold Voltage Vs. Junction Temperature

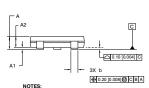
Fig 16. Typical Power Vs. Time

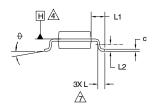


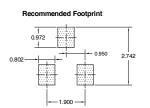
#### Micro3 (SOT-23) Package Outline

Dimensions are shown in millimeters (inches)









DIMENSIONS						
SYMBOL	MILLIMETERS		INCH	HES		
STWIDOL	MIN	MAX	MIN	MAX		
Α	0.89	1.12	0.035	0.044		
A1	0.01	0.10	0.0004	0.004		
A2	0.88	1.02	0.035	0.040		
b	0.30	0.50	0.012	0.020		
С	0.08	0.20	0.003	0.008		
D	2.80	3.04	0.110	0.120		
Е	2.10	2.64	0.083	0.104		
E1	1.20	1.40	0.047	0.055		
е	0.95	BSC	0.037	BSC		
e1	1.90	BSC	0.075	BSC		
L	0.40	0.60	0.016	0.024		
L1	0.54	REF	0.021	REF		
L2	0.25	BSC	0.010	BSC		
Ð	0	8	0	8		

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994
- DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
   CONTROLLING DIMENSION: MILLIMETER.
- A CONTROLLING DIMENSION MILLIMETER.

  ADATUM PLANE HIS LOCATED AT THE MOLD PARTING LINE.

  ADATUM AND B TO BE DETERMINED AT DATUM PLANE H.

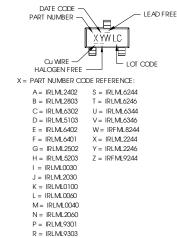
  ADMENSIONS D AND E1 ARE MEASUPED AT DATUM PLANE H. DIMENSIONS DOES NOT INCLIDE MOLD PROTRUSIONS OR INTERLEAD FLASH SHALL NOT EXCEED 0.25 MM [0.010 INCH] PER SIDE.

  ADMENSION LIS THE LEAD LEWISH FOR SOLDEFINIO TO A SUBSTRATE.

  8. OUTLINE CONFORMS TO JEDEC OUTLINE TO 228 AB.

#### Micro3 (SOT-23/TO-236AB) Part Marking Information

Notes: This part marking information applies to devices produced after 02/26/2001



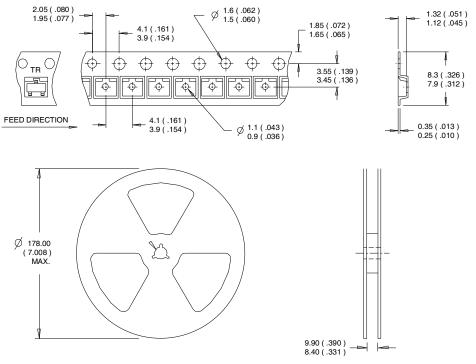
Note: Aline above the work week (as shown here) indicates Lead-Free.

DATE CO	DDE N	ИAR	KING IN	STRU	CTIONS
WW = (1-26) IF F	PREŒD	ED BY	LAST DIGIT	OF CALE	ENDAR YEA
YE,	AR	Υ	WORK WEEK	W	
2011 2012 2013 2014 2015 2016 2017 2018 2019 2020	2001 2002 2003 2004 2005 2006 2007 2008 2009 2010	1 2 3 4 5 6 7 8 9	01 02 03 04 24 25 26	A B C D X Y Z	
	(27-52) AR	) IF PR Y	ECEDED BY WORK WEEK	ALETTE W	R
2011 2012 2013 2014 2015 2016 2017 2018 2019 2020	2001 2002 2003 2004 2005 2006 2007 2008 2009 2010	A B C D E F G H J K	27 28 29 30	A B C D	

Note: For the most current drawing please refer to IR website at: http://www.irf.com/package/

#### Micro3™ (SOT-23) Tape & Reel Information

Dimensions are shown in millimeters (inches)



- CONTROLLING DIMENSION : MILLIMETER.
   OUTLINE CONFORMS TO EIA-481 & EIA-541.

Orderable part number	Package Type	Standard	Note	
Orderable part number	Package Type	Form	Quantity	
IRLML0040TRPbF	Micro3 (SOT-23)	Tape and Reel	3000	

#### Qualification information<sup>†</sup>

Qualification level	Cons umer <sup>††</sup>			
	(per JEDECJESD47F $^{\dagger\dagger\dagger}$ guidelines)			
	M:- ::- 0 (OOT 00)	MSL1		
Moisture Sensitivity Level	Micro3 (SOT-23)	(per IPC/JEDECJ-STD-020D <sup>†††</sup> )		
RoHS compliant	Yes			

- † Qualification standards can be found at International Rectifier's web site <a href="http://www.irf.com/product-info/reliability">http://www.irf.com/product-info/reliability</a>
- †† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information: <a href="http://www.irf.com/whoto-call/salesrep/">http://www.irf.com/whoto-call/salesrep/</a>
- ††† Applicable version of JEDEC standard at the time of product release.

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width  $\leq$  400 $\mu$ s; duty cycle  $\leq$  2%.
- 3 Surface mounted on 1 in square Cu board
- Refer to <u>application note #AN-994.</u>

Data and specifications subject to change without notice.



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